



Through Hole Lamp Product Data Sheet LTL14CYTBFJ1H183

Spec No.: DS20-2013-0304

Effective Date: 11/19/2013

Revision: -

LITE-ON DCC

RELEASE

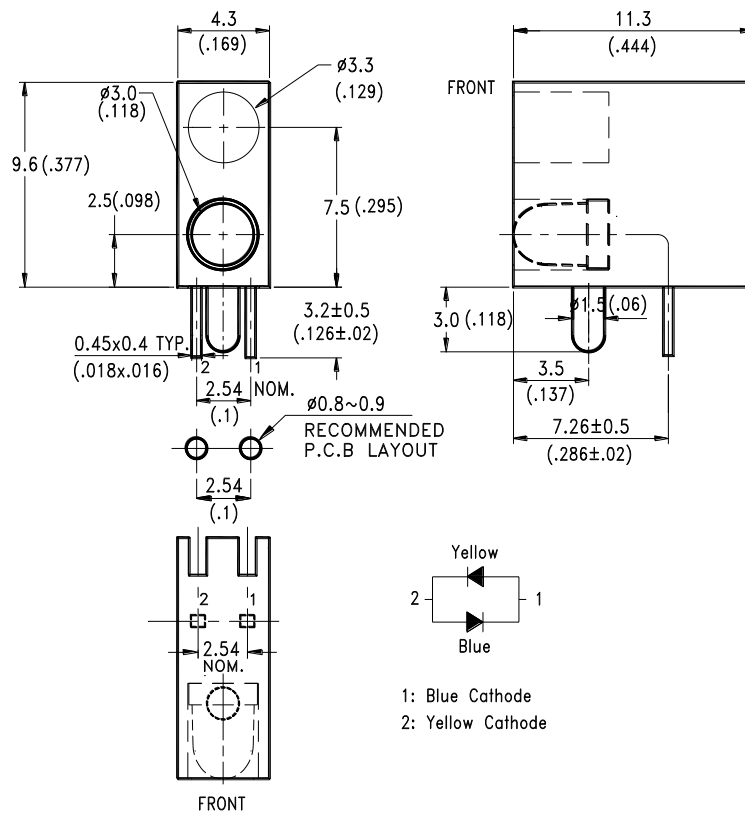
BNS-OD-FC001/A4

Property of Lite-On Only

Features

- * Lead (Pb) free product – RoHS compliant.
- * Designed for ease in circuit board assembly.
- * Black case enhance contrast ratio.
- * Solid state light source.
- * Reliable and rugged.

Package Dimensions



Part No.	Lens	Source Color
LTL14CYTBFJ1H183	White Diffused	AlInGaP Yellow / InGaN Blue

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{mm}$ (.010") unless otherwise noted.
3. The Holder (Housing) is 46L183, PA66+33%GF black.
4. The LED lamp is LTL14CYTBFJ (Yellow/Blue bi-color).
5. Specifications are subject to change without notice.



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Absolute Maximum Ratings at $T_A=25^\circ\text{C}$

Parameter	Yellow	Blue	Unit
Power Dissipation	52	72	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	100	mA
Continuous Forward Current	20	20	mA
Operating Temperature Range	-40°C to $+85^\circ\text{C}$		
Storage Temperature Range	-40°C to $+100^\circ\text{C}$		
Lead Soldering Temperature [2 mm (.08") From Body]	260°C for 5 Seconds Max.		

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Electrical / Optical Characteristics at T_A=25°C

Parameter	Symbol	Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I _v	Yellow Blue		120 240		mcd	I _F = 20mA I _F = 20mA Note 1,4
Viewing Angle	2θ _{1/2}	Yellow Blue		80 80		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ _p	Yellow Blue		591 468		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ _d	Yellow Blue		590 470		nm	I _F = 20mA Note 3
Spectral Line Half-Width	Δλ	Yellow Blue		20 25		nm	
Forward Voltage	V _F	Yellow Blue		2.1 3.2		V	I _F = 20mA
Reverse Current	I _R	Yellow Blue			100	μA	V _R = 5V Note 5

Note: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclairage) eye-response curve.

2. θ_{1/2} is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength, λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

4. The I_v guarantee should be added ±30%.

5. Reverse current is controlled by dice source.

6. Reverse Voltage (V_R) condition is applied for IR test only. The device is not designed for reverse operation.

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Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

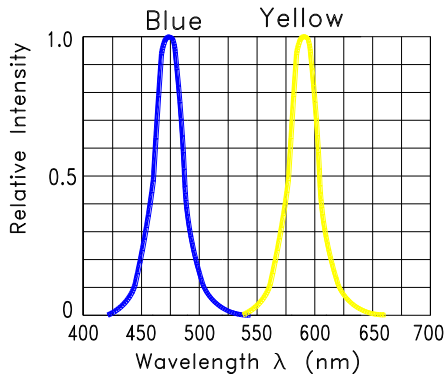


Fig.1 Relative Intensity VS. Wavelength

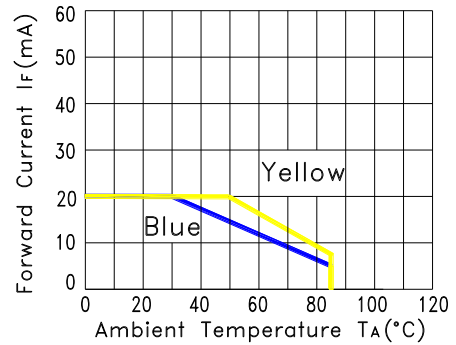


Fig.2 Forward Current Derating Curve

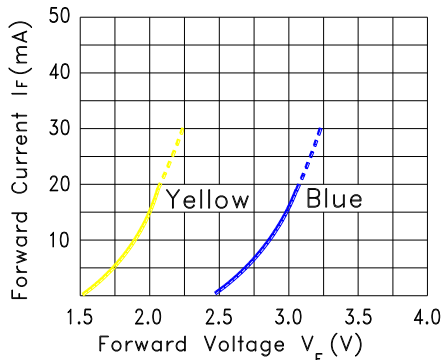


Fig.3 Forward Current vs. Forward Voltage

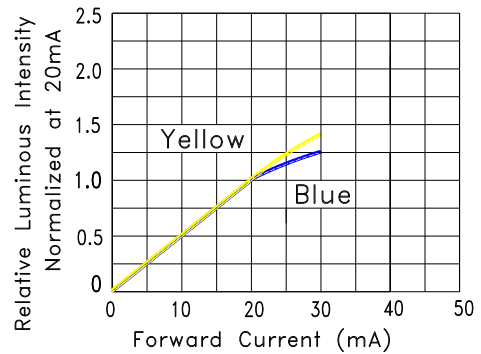


Fig.4 Relative Luminous Intensity vs. Forward Current

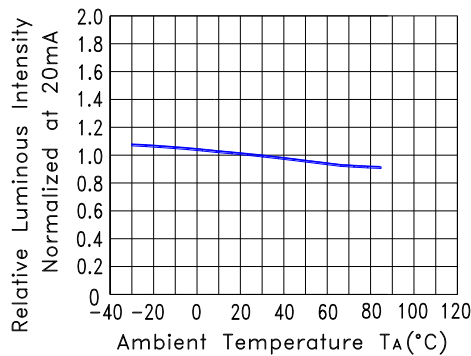


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

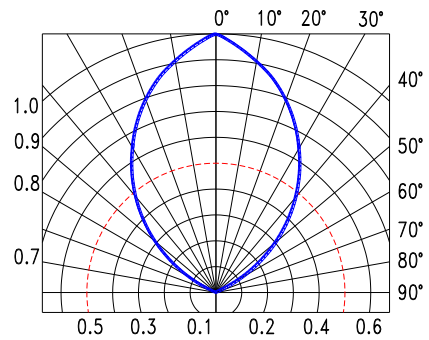
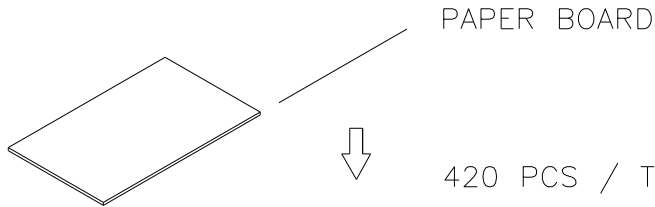


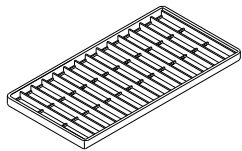
Fig.6 Spatial Distribution

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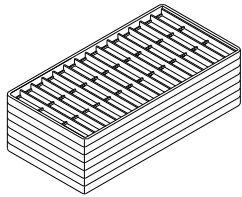
Packing Spec



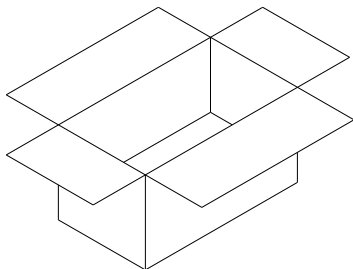
420 PCS / TRAY



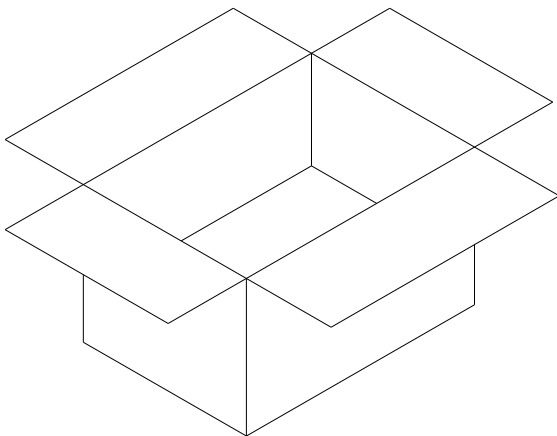
11 TRAYS / LOT
LOT TOTAL:4,620 Pcs



1 LOT / INNER CARTON
TOTAL : 4,620Pcs
(I-CARTON : 300 X 165 X 130 nm)



8 I-CARTON/INNER CARTON
TOTAL : 36,960Pcs
(O-CARTON : 610 X 350 X 280 nm)



CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3 mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens/Holder to the soldering point. Dipping the lens/Holder into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions :

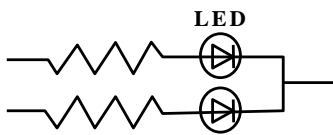
Soldering iron		Wave soldering	
Temperature	350°C Max.	Pre-heat	100°C Max.
Soldering time	3 sec. Max. (one time only)	Pre-heat time	60 sec. Max.
		Solder wave	260°C Max.
		Soldering time	5 sec. Max.

Note: Excessive soldering temperature and/or time might result in deformation of the LED/Holder or catastrophic failure of the CBI. IR(Hot air) re-flow is not suitable process for through hole type LED lamp production. Max. temperature of wave soldering is not mean that Holder's HDT/Melting temperature.

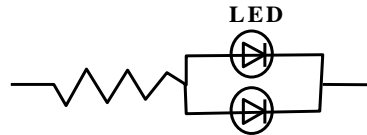
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



(A) Recommended circuit

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handling



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Suggested checking list :

Training and Certification

1. Everyone working in a static-safe area is ESD-certified?
2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

1. Static-safe workstation or work-areas have ESD signs?
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?
4. Each work surface mats grounding is good?

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
2. If conductive footwear used, conductive flooring also present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for Blue LED.

Device Handling

1. Every ESDS items identified by EIA-471 labels on item or packaging?
2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

1. Audit result reported to entity ESD control coordinator?
2. Corrective action from previous audits completed?
3. Are audit records complete and on file?



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8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life (LT)	Ta = under room temperature IF = per datasheet maximum drive current Test time = 1000 hrs	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High temperature/ High humidity storage (THB)	Ta = 60 °C RH = 90% Test time = 240hrs	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
	High temperature storage	Ta = 105 ± 5°C Test time = 1000 hrs	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low temperature storage	Ta = -55 ± 5°C Test time = 1000 hrs	JEITA ED-4701: 200 202 (2001)
Environmental Test	Temperature cycling	100°C ~ 25°C ~ -40°C ~ 25°C 30 mins 5 mins 30 mins 5 mins 30 cycles	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal shock	100 ± 5°C ~ -30 ± 5°C 15 mins 15 mins 30 cycles (< 20 secs transfer)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
	Solder resistance (no pre-condition)	T.sol = 260 ± 5°C Dwell time = 10 ± 1 sec	MIL-STD-750D:2031 (1995) JEITA ED-4701: 300 302 (2001)
	Solderability (no pre-condition)	T.sol = 245 ± 5°C Dwell time = 5 ± 0.5 sec	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron (no pre-condition)	T.sol = 350 ± 5°C Dwell time = 3.5 ± 0.5 sec	MIL-STD-202G:208H (2002) JEITA ED-4701: 300 302 (2001)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.